



100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D T _C = +25°C
100V	28mΩ @ VGS = 10V	40A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine management systems
- Body control electronics
- DC-DC converters

Features

- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMNH10H028SPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

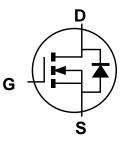
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

Site 1:

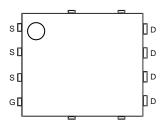
Top View



Bottom View



Internal Schematic



Top View Pin Configuration

Site 2:

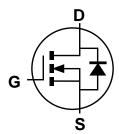
PowerDI5060-8/SWP (Type UX)



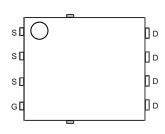
Top View



Bottom View



Internal Schematic



Top View Pin Configuration

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



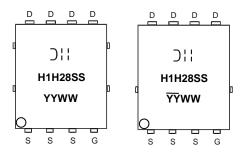
Ordering Information (Note 4)

Part Number	Pookogo	Packing			
Part Number	Package	Qty.	Carrier		
DMNH10H028SPSQ-13	PowerDI5060-8	2,500	Tape & Reel		
DMNH10H028SPSQ-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel		

Note:

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	100	V		
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current, Vgs = 10V	lo	40 25	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) (Note 5)			I _{DM}	54	Α
Maximum Continuous Body Diode Forward Current (Note 6)			Is	3.9	Α
Avalanche Current (Note 8) L=0.1mH			las	26	Α
Avalanche Energy (Note 8) L=0.1mH			E _{AS}	35	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	$R_{\theta JA}$	97	°C/W
Total Power Dissipation (Note 6)		PD	2.9	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	$R_{\theta JA}$	52	°C/W
Thermal Resistance, Junction to Case		R _θ JC	1.8	C/VV
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.



Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μΑ	V _{DS} = 100V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	2.0	2.5	4.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R _{DS(ON)}		19	28	mΩ	$V_{GS} = 10V, I_D = 20A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1.0A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2245	_		V _{DS} = 50V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	_	173	_	pF		
Reverse Transfer Capacitance	Crss	_	68	_			
Gate Resistance	Rg	_	1.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg	_	36	_			
Total Gate Charge (V _{GS} = 6.0V)	Qg	_	22	_	nC	N/ 50V/ L 00A	
Gate-Source Charge	Qgs	_	7.3	_	nc nc	V _{DD} = 50V, I _D = 20A	
Gate-Drain Charge	Q_{gd}	_	9.2	_			
Turn-On Delay Time	td(on)	_	6.4	_			
Turn-On Rise Time	t _R	_	5.8	_		$V_{GS} = 10V$, $V_{DS} = 50V$, $R_{G} = 3.0\Omega$, $I_{D} = 20A$	
Turn-Off Delay Time	tD(OFF)	_	17.8	_	ns		
Turn-Off Fall Time	tr	_	4.8	_			
Reverse Recovery Time	trr	_	35	_	ns	I _F = 20A, di/dt = 100A/μs	
Reverse Recovery Charge	Qrr		47		nC	I _F = 20A, di/dt = 100A/μs	

7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:



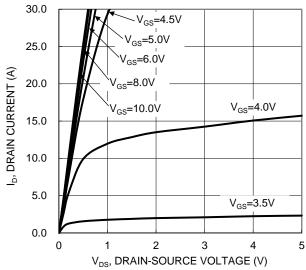


Figure 1. Typical Output Characteristic

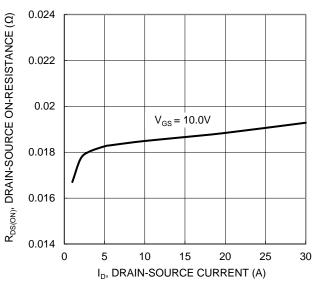


Figure 3. Typical On-resistance vs. Drain Current and Gate Voltage

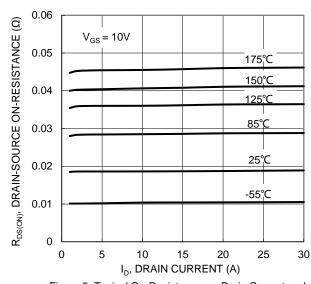
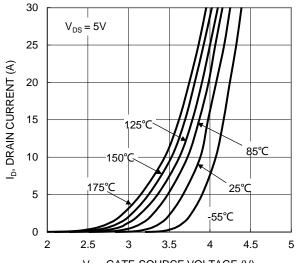


Figure 5. Typical On-Resistance vs. Drain Current and Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

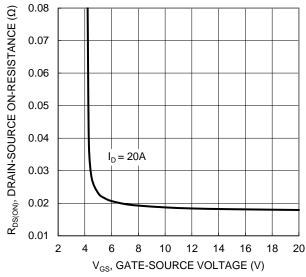


Figure 4. Typical Transfer Characteristic

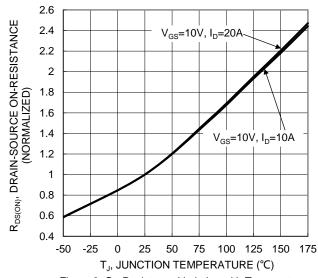


Figure 6. On-Resistance Variation with Temperature



DMNH10H028SPSQ

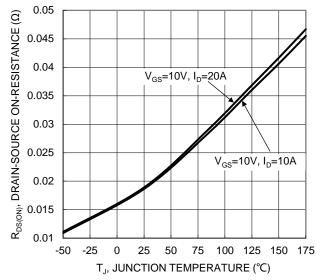


Figure 7. On-Resistance Variation with Temperature

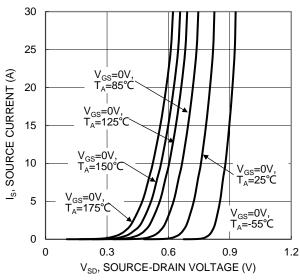
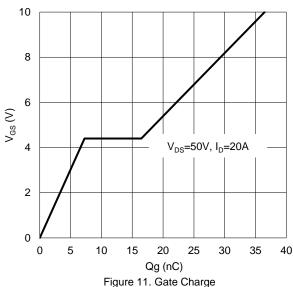


Figure 9. Diode Forward Voltage vs. Current



3.2 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 3 2.8 2.6 2.4 $I_D=1mA$ 2.2 2 $I_{D} = 250 \mu A$ 1.8 1.6 1.4 1.2 -25 -50 0 25 50 75 100 125 150 T_J, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature

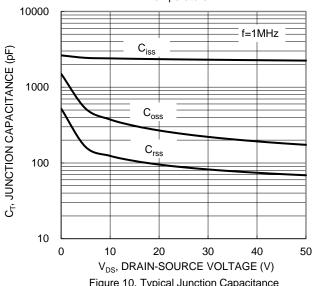


Figure 10. Typical Junction Capacitance

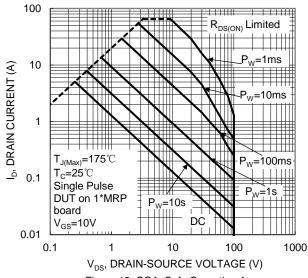


Figure 12. SOA, Safe Operation Area



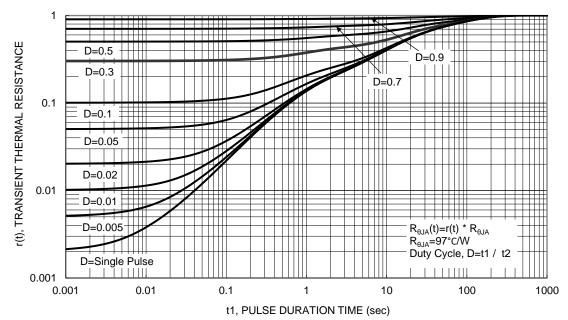


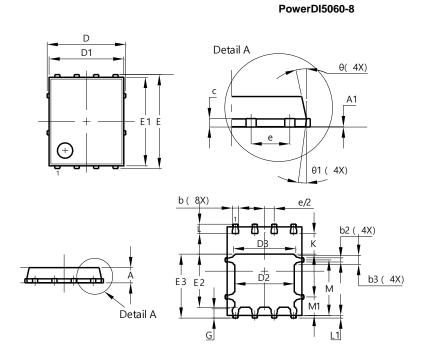
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

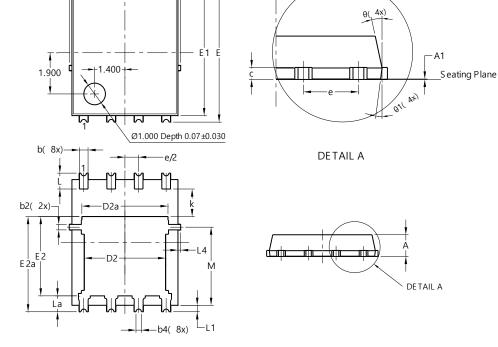
Site 1:



PowerDI5060-8 Dim Min Max Tyl A 0.90 1.10 1.0 A1 0.00 0.05 − b 0.33 0.51 0.4 b2 0.200 0.350 0.27 b3 0.40 0.80 0.6 c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC E1 5.60 6.00 5.8	0			
A 0.90 1.10 1.0 A1 0.00 0.05 - b 0.33 0.51 0.4 b2 0.200 0.350 0.27 b3 0.40 0.80 0.6 c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC	0			
A 0.90 1.10 1.0 A1 0.00 0.05 - b 0.33 0.51 0.4 b2 0.200 0.350 0.27 b3 0.40 0.80 0.6 c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC	0			
b 0.33 0.51 0.4 b2 0.200 0.350 0.27 b3 0.40 0.80 0.6 c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC	1			
b2 0.200 0.350 0.27 b3 0.40 0.80 0.6 c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC	1			
b3 0.40 0.80 0.6 c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC				
c 0.230 0.330 0.27 D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC	73			
D 5.15 BSC D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC	0			
D1 4.70 5.10 4.9 D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC	77			
D2 3.70 4.10 3.9 D3 3.90 4.30 4.1 E 6.15 BSC				
D3 3.90 4.30 4.1 E 6.15 BSC	0			
E 6.15 BSC	0			
	0			
E1 5.60 6.00 5.8				
	0			
E2 3.28 3.68 3.4	8			
E3 3.99 4.39 4.1	9			
e 1.27 BSC				
G 0.51 0.71 0.6	1			
K 0.51 – –				
L 0.51 0.71 0.6	1			
L1 0.100 0.200 0.17	75			
M 3.235 4.035 3.63	35			
M1 1.00 1.40 1.2				
Θ 10° 12° 11	0			
Θ1 6° 8° 7°				
All Dimensions in mm				

Site 2:

PowerDI5060-8/SWP (Type UX)



PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	().25REF	•	
С	0.230	0.330	0.277	
D	5	.15 BS0)	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
E	6.40 BSC			
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е		.27BSC		
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

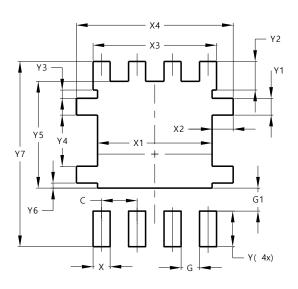


Suggested Pad Layout

 $\label{prop:package-outlines.html} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

Site 1:

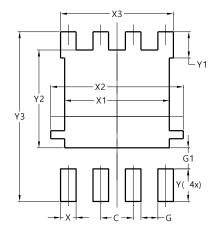
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Υ	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value	
	(in mm)	
С	1.270	
G	0.660	
G1	0.820	
X	0.610	
X1	4.100	
X2	5.190	
Х3	4.420	
Y	1.270	
Y1	1.020	
Y2	3.810	
Y3	6.610	



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